

Charge-Storage Related Parameter Calculation for Si/SiGe Bipolar Transistors from Device Simulation

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OUTLINE

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Introduction

Bipolar transistor main application areas

- high-frequency/high-speed operation

Circuit design constraints

- cost reduction (mask, re-spins..., yield prediction)
- some applications are close to the technology limit \Rightarrow careful circuit optimization

Process development and optimization

- evaluation of charge and delay components within device structure

\Rightarrow **accurate physics-based modeling of charge storage effects**

Existing methods for analyzing charge storage

analytical solutions

- require strong simplifications of underlying semiconductor equations
- spatial partitioning into neutral region (NR) and space-charge region (SCR) by *definition of abrupt boundaries* (**Regional Approach = RA**)
 - ⇒ validity of results is limited to particular spatial and bias region

device simulation

- yields detailed information on carrier and charge distributions
- no limitation of results w.r.t. certain spatial or bias regions
- however: no abrupt boundaries between spatial regions either

desirable:

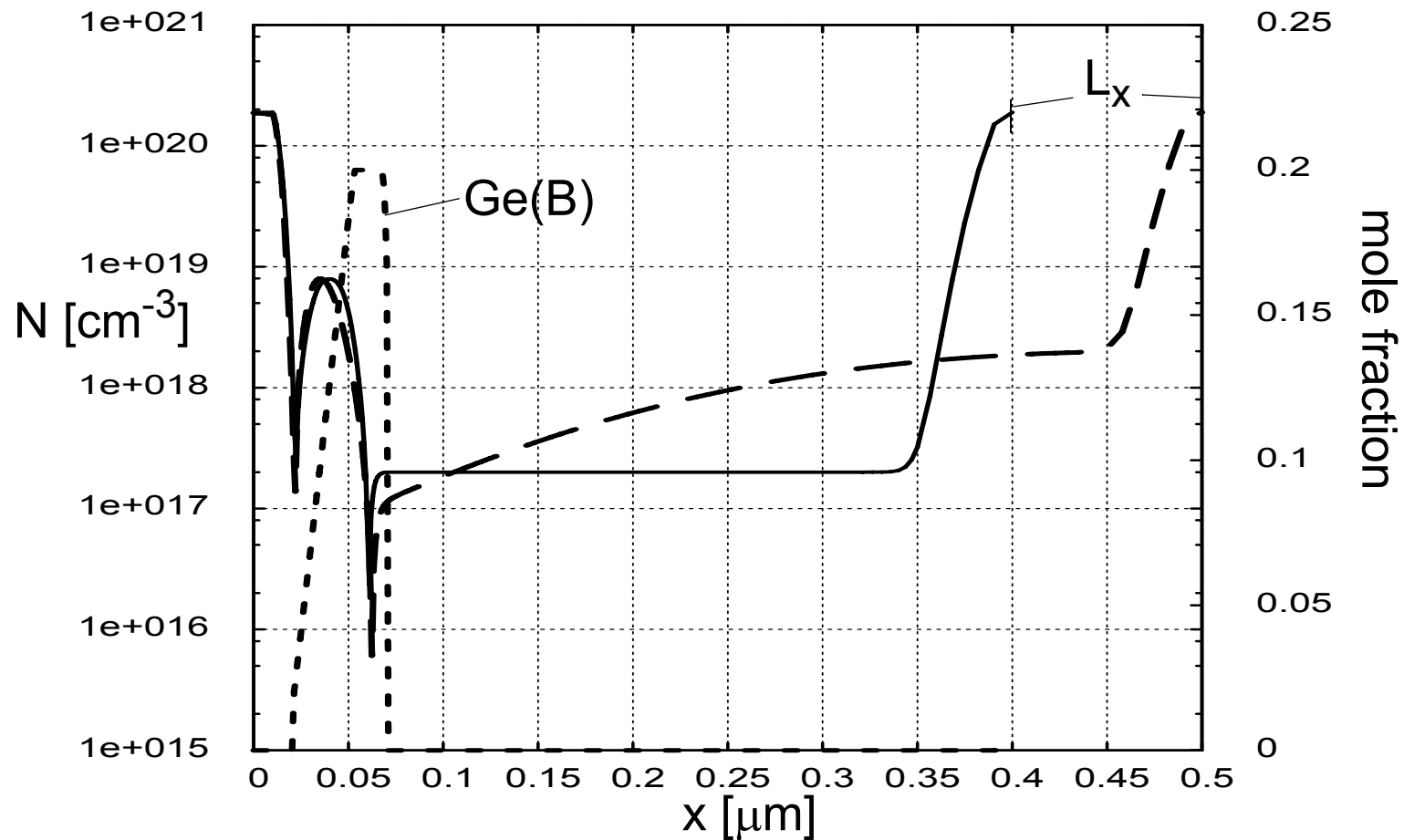
charge storage components from device simulation as reference for analytical modeling

⇒ this work: evaluation of possible RA options for device simulation

Investigated Device Structures

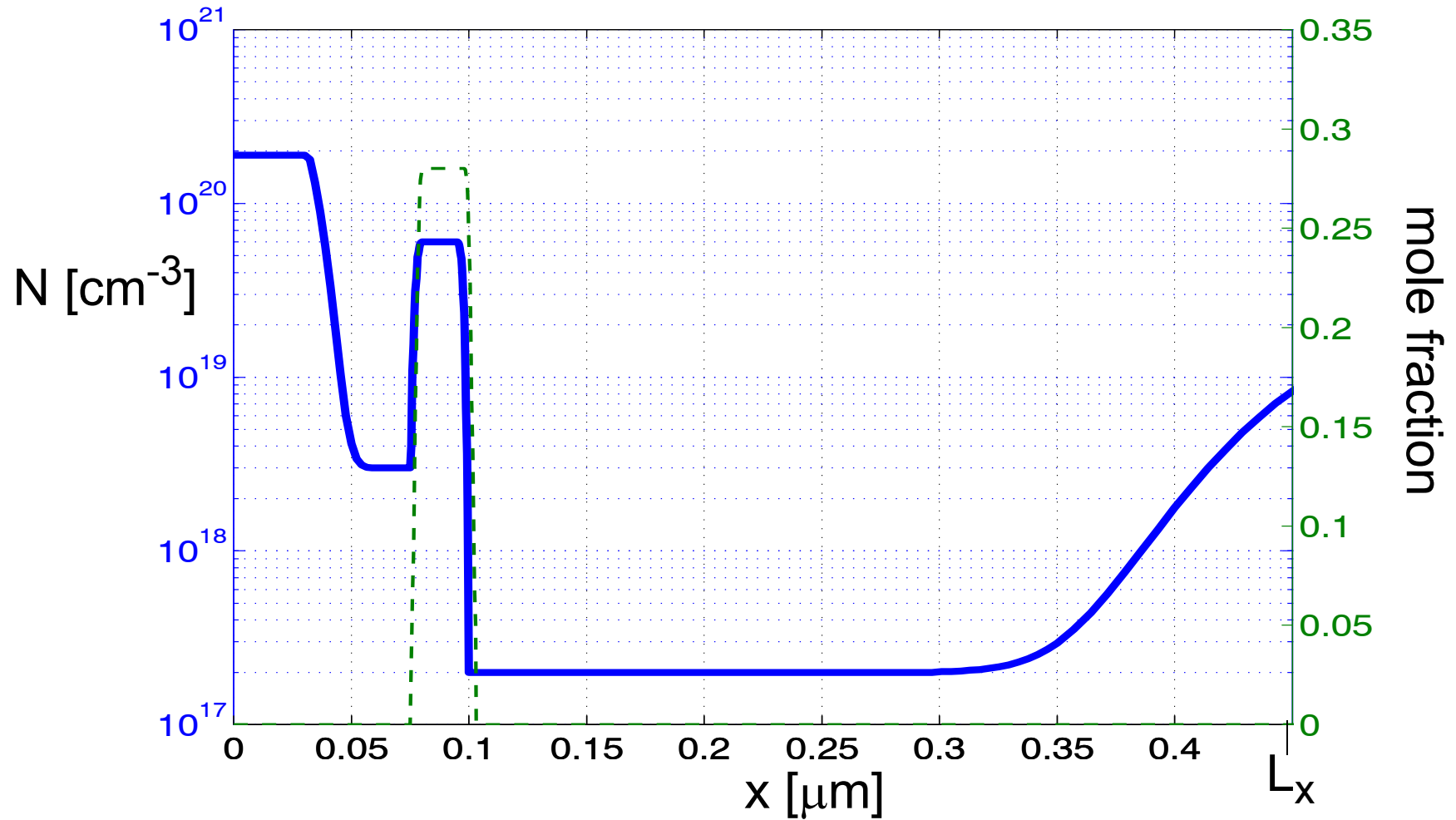
1D device simulation: unit emitter area $A_E = 1 \mu\text{m}^2$

conventional emitter doping (CED) transistor: high-speed BJT, HBT version

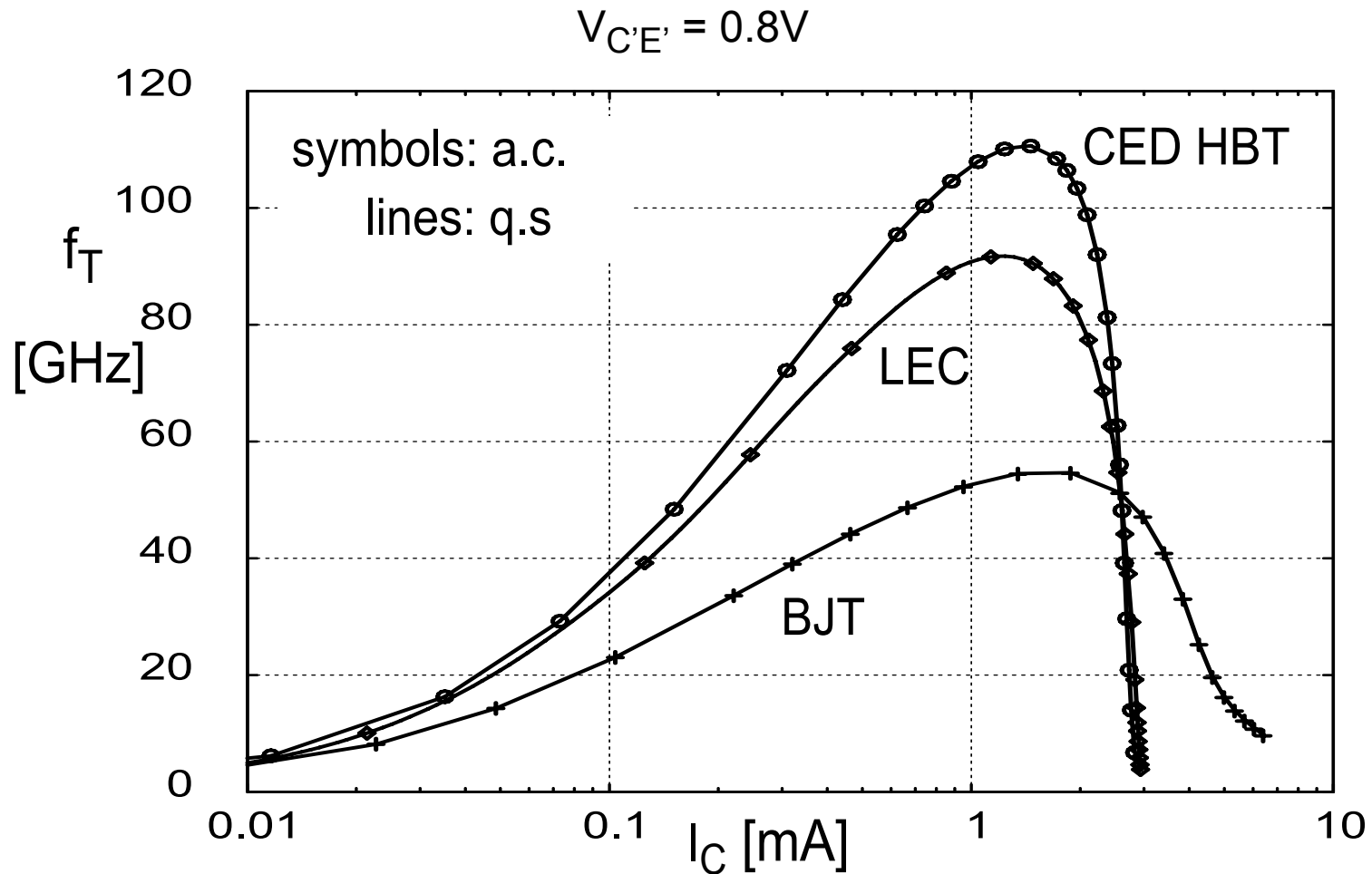


Device Structures

low-emitter concentration (LEC) transistor: high-speed HBT version



High-frequency performance: transit frequency



- identical results for quasi-static and frequency dependent small-signal calculation
 ⇒ partitioning of transit time based on carrier distribution

Overview on Regional Approach Methods

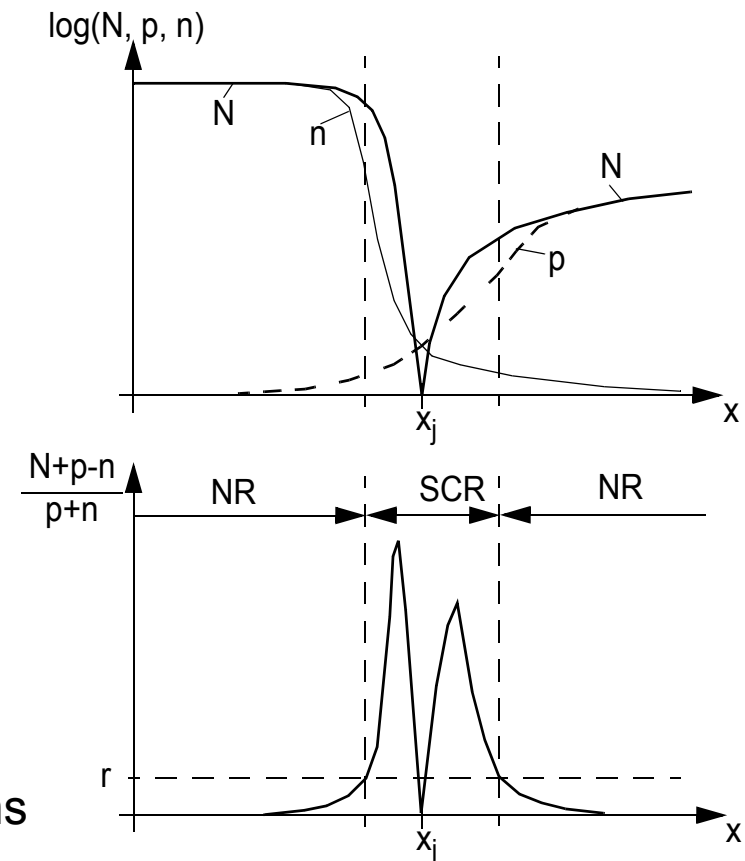
d.c. method(s)

- determination of NR-SCR boundary is based on static carrier distribution
- classical criterion for detecting point in SCR:
majority carrier density $< r \cdot$ doping conc.,
with $r \ll 1$
 - works only for sufficiently low-injection
 - does not work in center region of SCR
($N \rightarrow 0$ but carrier densities remain finite)
- normalized boundary condition:

$$x_r = x \left(\frac{N+p-n}{p+n} \geq r \right) \quad \text{with } r \ll (<) 1$$

- works also for high injection
- search needs to start from neutral region

⇒ designated as DCRA and used for comparisons

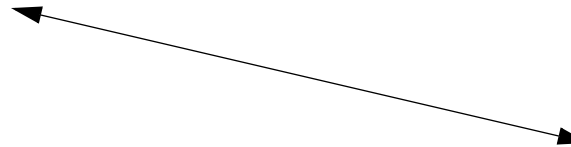


problem: missing link to small-signal operation

Small-signal based regional approaches

- link to small-signal *measurements*

- via relation between transit frequency and stored hole charge: $\frac{1}{2\pi f_T} = \tau_{ec} = \left. \frac{dQ_p}{dI_C} \right|_{V_{CE}}$

$$\text{with } dQ_p = qA_E \int_0^{L_x} \partial p \, dx$$


- region boundaries detected from *quasi-static* small-signal carrier distribution
- comparison of 3 methods

Regional Approach Methods: van den Biesen [6]

- popular for evaluating device simulation results
- replaces *metallurgical* boundaries by *electrical* boundaries: $x_m = x(dp = dn)$

- storage time partitioning: $\left. \frac{dQ_p}{dI_C} \right|_{V_{CE}} \equiv \tau_{ec} = \tau_e^* + \tau_{eb} + \tau_b^* + \tau_{bc} + \tau_c^*$

- minority carrier storage times, e.g.:

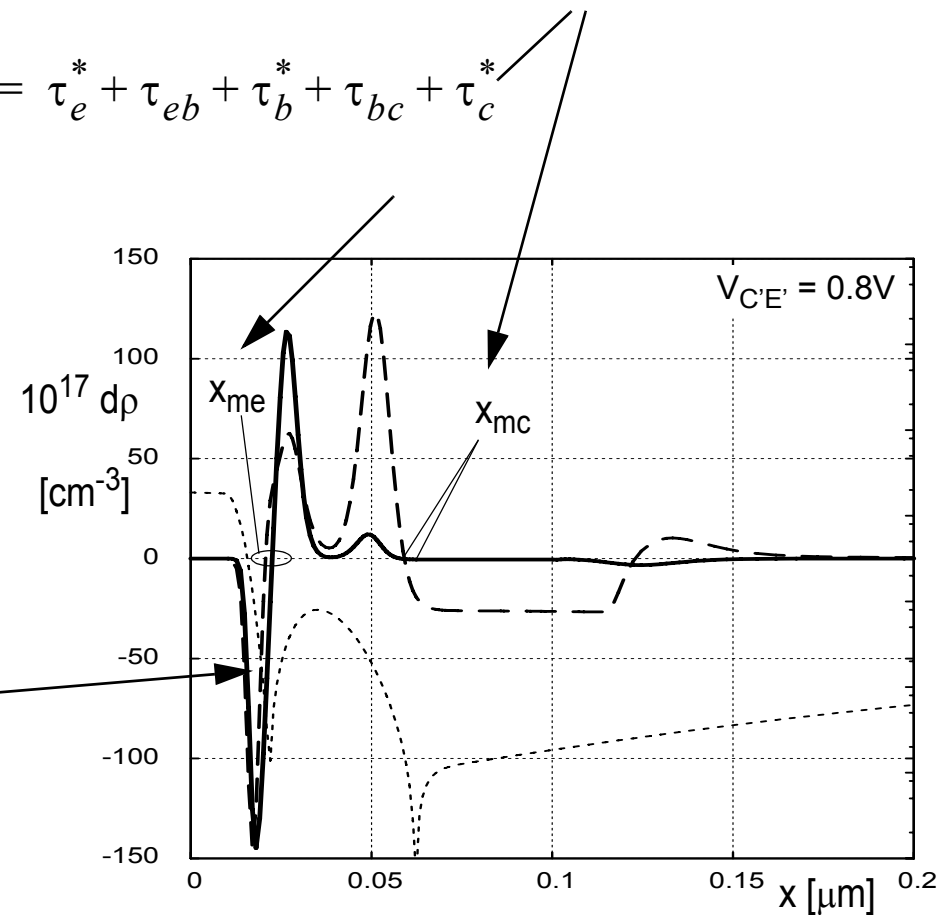
$$\tau_b^* = qA_E \int_{x_{me}}^{x_{mc}} \left. \frac{\partial n}{\partial I_C} \right|_{V_{CE}} dx$$

- depletion region "charging times", e.g.:

$$\tau_{eb} = qA_E \int_0^{x_{me}} \left. \frac{\partial(n-p)}{\partial I_C} \right|_{V_{CE}} dx$$

- no separation of NR and SCR

⇒ **not suitable for compact modeling!**



Regional Approach Methods: FRA (1/1)

- region boundaries from peaks of $(\partial p - \partial n)$
 - Note: BC SCR boundaries cannot be detected from CE short distribution!
- separation into BE and BC voltage change:

$$dQ_p = \left. \frac{\partial Q_p}{\partial V_{B'E'}} \right|_{V_{B'C}} dV_{B'E'} + \left. \frac{\partial Q_p}{\partial V_{B'C}} \right|_{V_{B'E'}} dV_{B'C}$$

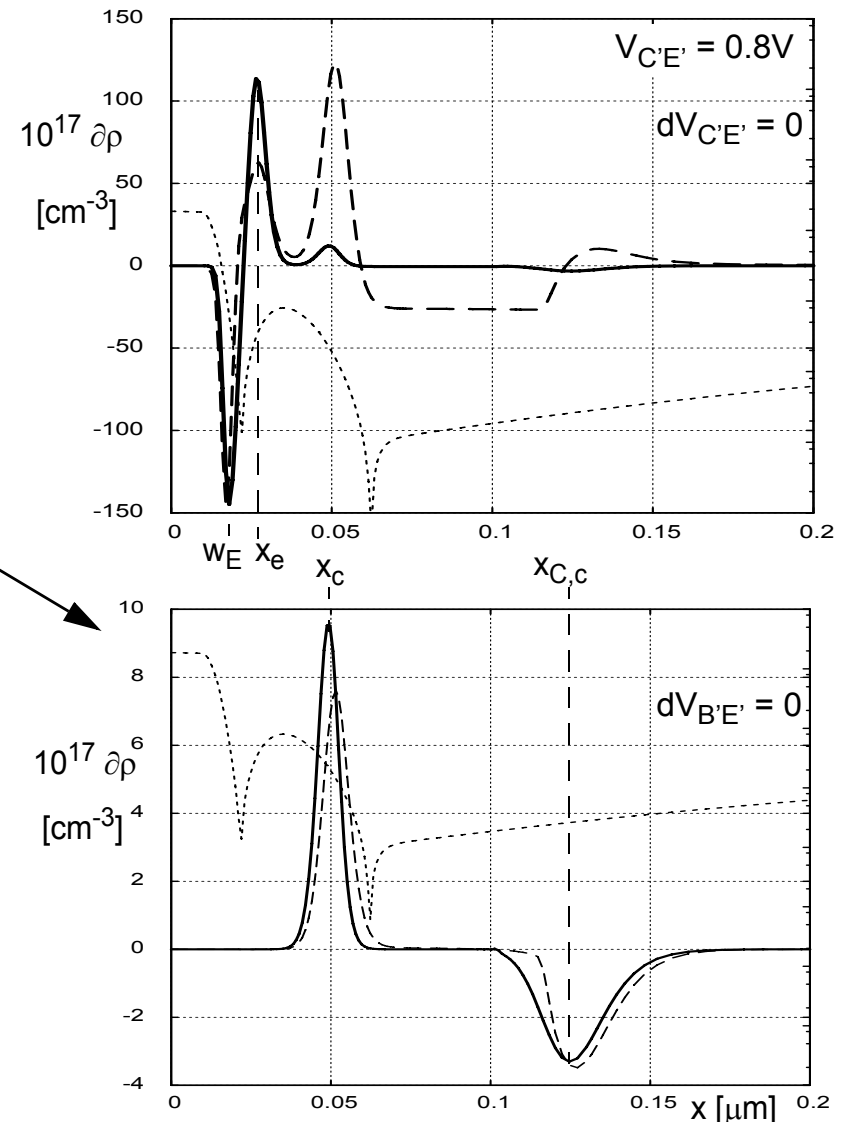
- minorities: $\partial m = \begin{cases} \partial p & , |\partial p| < |\partial n| \\ \partial n & , |\partial n| \leq |\partial p| \end{cases}$

- hole charge partitioning: $dQ_p = dQ_j + dQ_m$

⇒ depletion charge

$$dQ_j = dQ_p - dQ_m = qA_E \int_{w(\partial p < \partial n)} \partial(n - p) dx$$

⇒ consistent with (q.s.) definition of f_T



Full regional approach (2/1)

- minority carrier storage time components from accumulated storage time:

$$\tau_m(x) = qA_E \int_0^x \frac{\partial m}{\partial I_C} \Big|_{V_{CE}} d\xi \longrightarrow \tau_m(x)$$

- space-charge modulation in BC SCR:

$$C_{cE} = qA_E \int_{x_{mc}}^{L_x} \frac{\partial(-\rho)}{\partial V_{B'E'}} \Big|_{V_{B'C}} dx$$

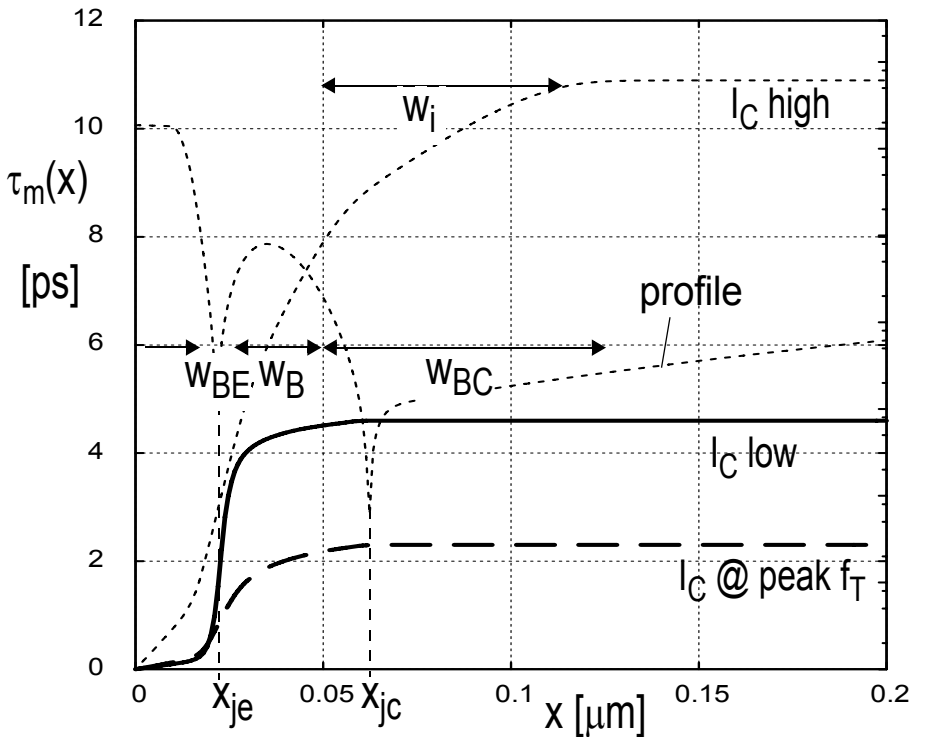
= cross-coupled capacitance

- total value: $\tau_f = \tau_m(L_x) + \frac{C_{cE}}{g_{mi}}$

- depletion capacitances:

$$C_{jEi} = qA_E \int_0^{x_{me}} \frac{\partial(-\rho)}{\partial V_{B'E'}} \Big|_{V_{B'C}} dx$$

$$C_{jCi} = qA_E \int_{x_{mc}}^{L_x} \frac{\partial(-\rho)}{\partial V_{B'C}} \Big|_{V_{B'E'}} dx$$

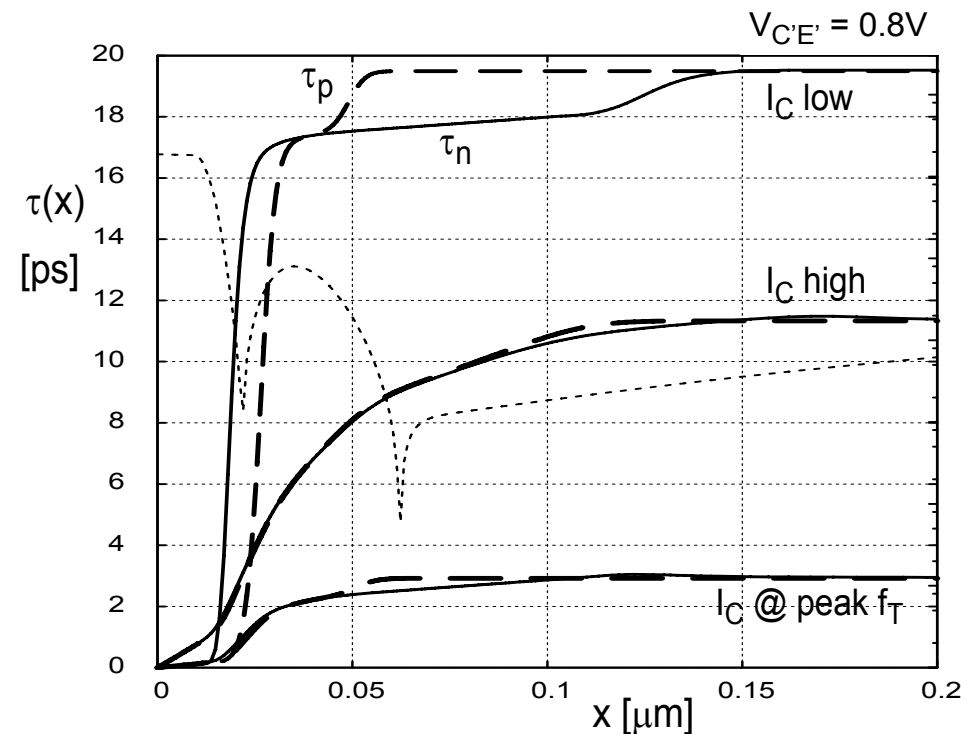


Regional Approach Methods: DTRA [11]

- proposed for evaluation of device simulation results
- SCR boundary defined as 5% difference between accumulated carrier storage times

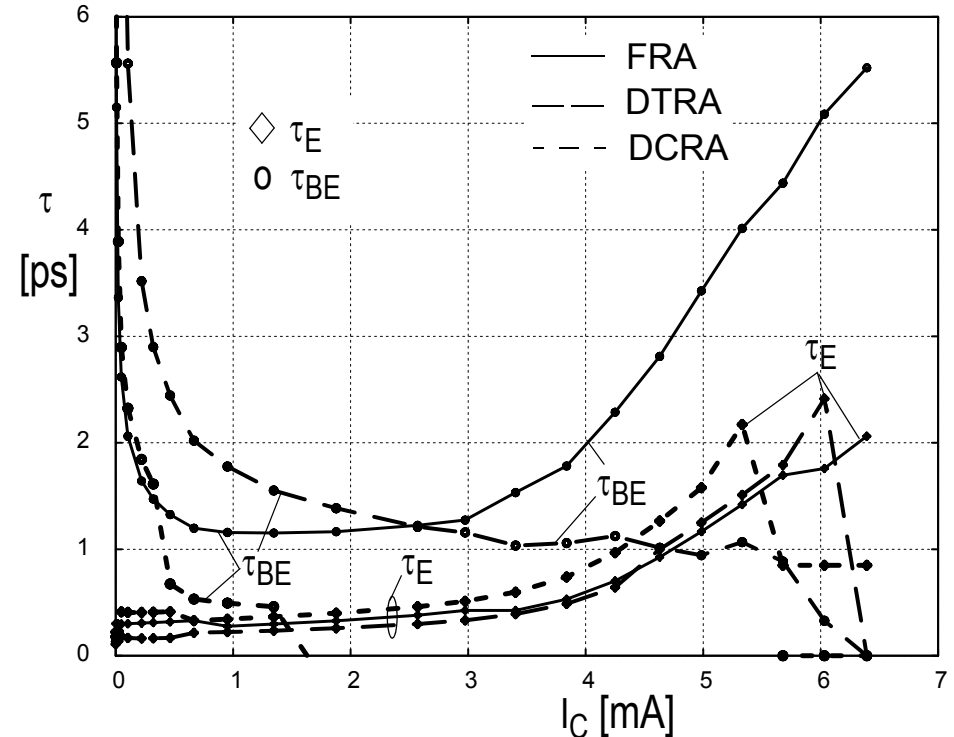
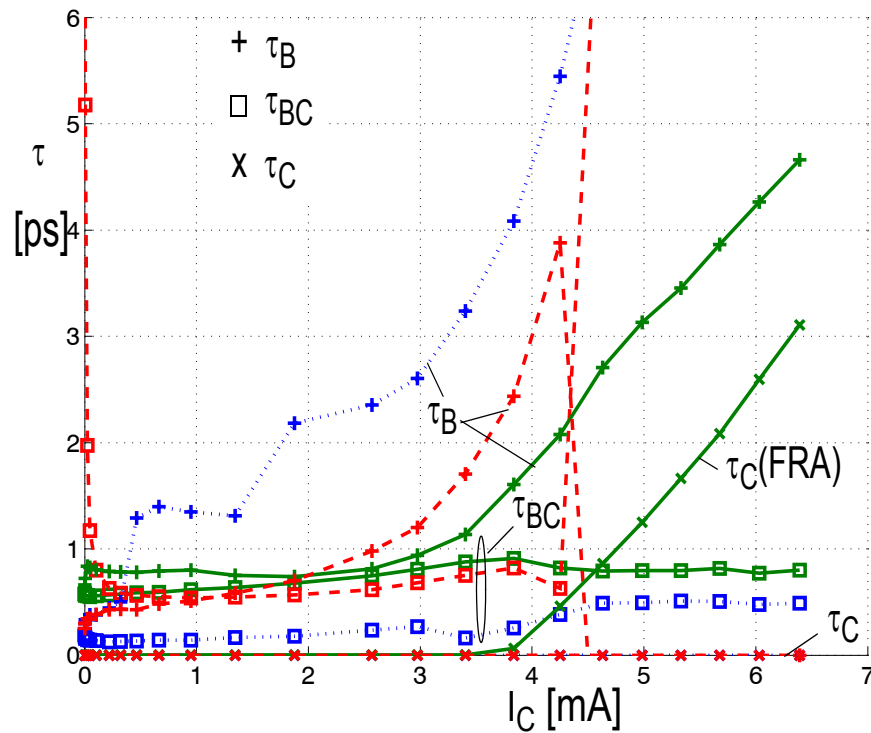
$$\tau_n(x) = qA_E \int_0^x \frac{\partial n}{\partial I_C} \Big|_{V_{CE}} d\xi, \quad \tau_p(x) = qA_E \int_0^x \frac{\partial p}{\partial I_C} \Big|_{V_{CE}} d\xi$$

- storage times include depletion charge contributions (C_j/g_m)
- does not allow reliable detection of BC SCR end
- boundary detection difficult at high injection
- correction of $\tau_E \rightarrow (2/3)\tau_E$ based on non-quasi-static operation
 \Rightarrow ignored here



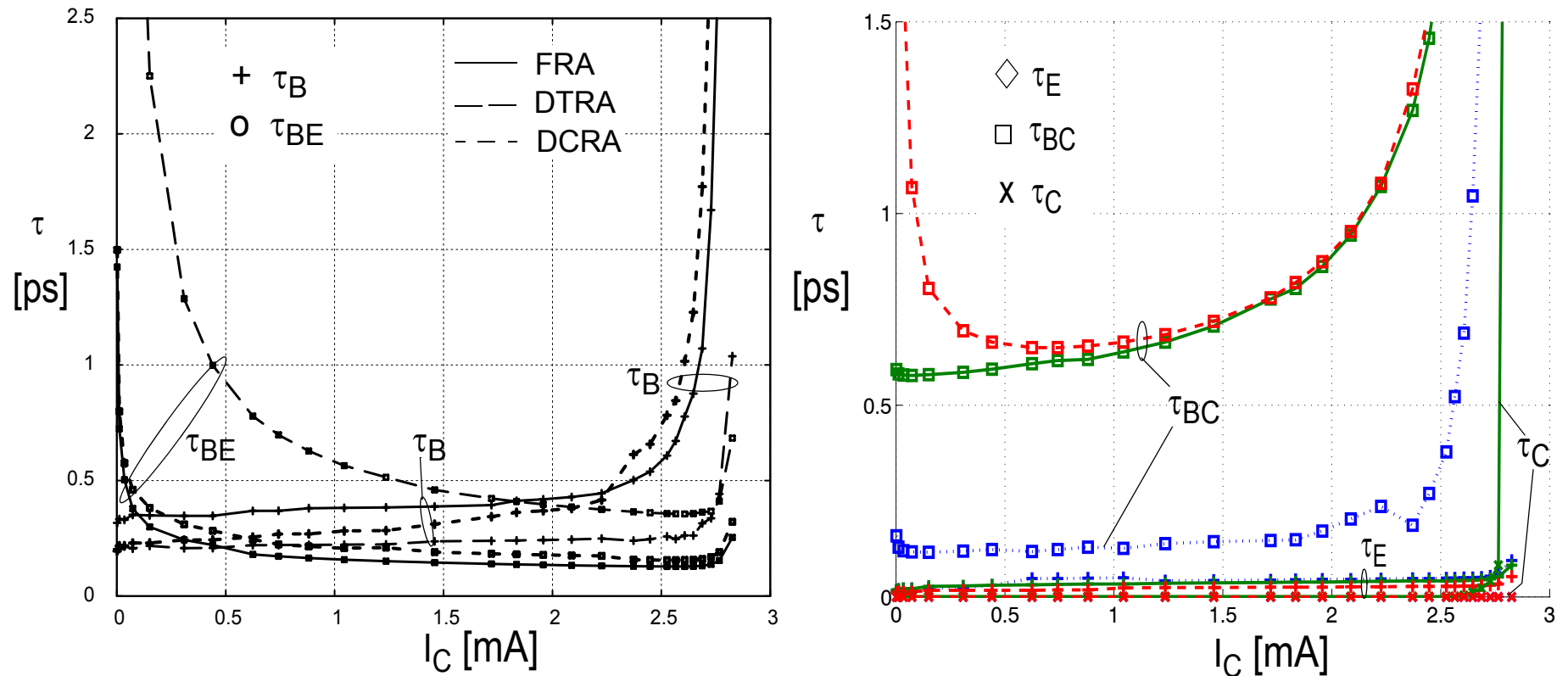
Results and Discussion

BJT storage time components ($V_{C'E'} = 0.8V$)



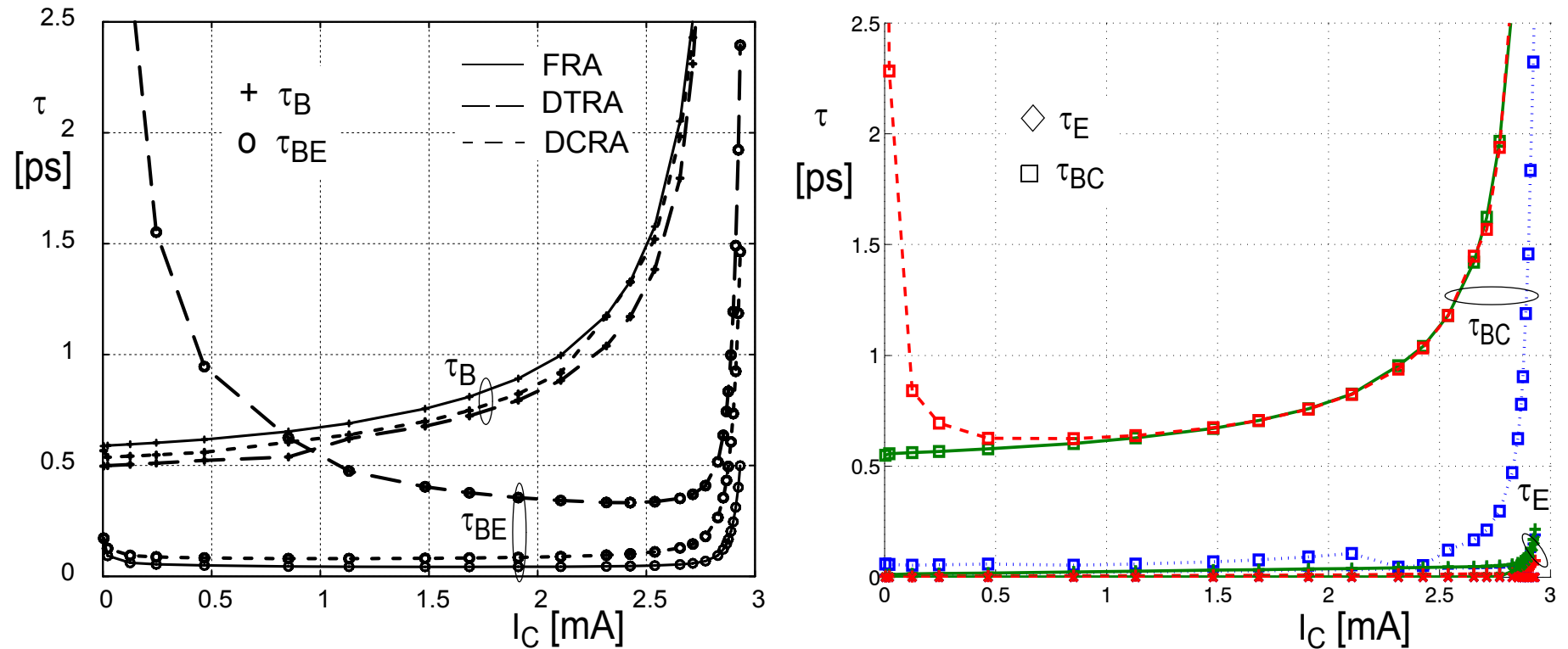
- neutral base: τ_B differs significantly; discontinuous for DTRA due to Kirk effect
- BC SCR: τ_{BC} similar for FRA & DTRA, but too small for DCRA (τ_m only)
- BE SCR: τ_{BE} differs significantly, discontinuous for DCRA (no x_e detection)
- neutral collector: τ_C not detected by DCRA and DTRA

CED HBT storage time components ($V_{C'E'} = 0.8V$)



- neutral base: τ_B more consistent; DTRA does not detect carrier jam properly
- BC SCR: τ_{BC} similar for FRA & DTRA; difference at low I_C due to C_{jCi}/g_m in DTRA
- BE SCR: τ_{BE} more consistent; DTRA and FRA similar
- neutral collector (τ_C): small injection zone is detected by FRA, not by DTRA, DCRA

LEC HBT storage time components ($V_{C'E'} = 0.8V$)



- neutral base: τ_B dominates, detected fairly consistently for all methods
- BC SCR: τ_{BC} identical for FRA & DTRA, increase due to barrier
- BE SCR: τ_{BE} similar for DCRA and FRA; DTRA includes C_{jEi}/g_m (low I_C)
- neutral collector (τ_C) and emitter (τ_E): negligible due to barriers

Conclusions

- several approaches for regional partitioning in Si-based HBTs have been investigated regarding their suitability for *device simulation and compact modeling* use
- d.c. carrier distribution based methods are unreliable
- small-signal quasi-static carrier distribution based methods:
 - van den Biesen's scheme is not useful for *compact modeling*
 - differential transit time approach (DTRA) is unreliable for BJTs, does not detect boundaries in the collector
 - extended space-charge peak based regional approach (FRA) gives reliable physically reasonable results that can be linked directly to compact model development

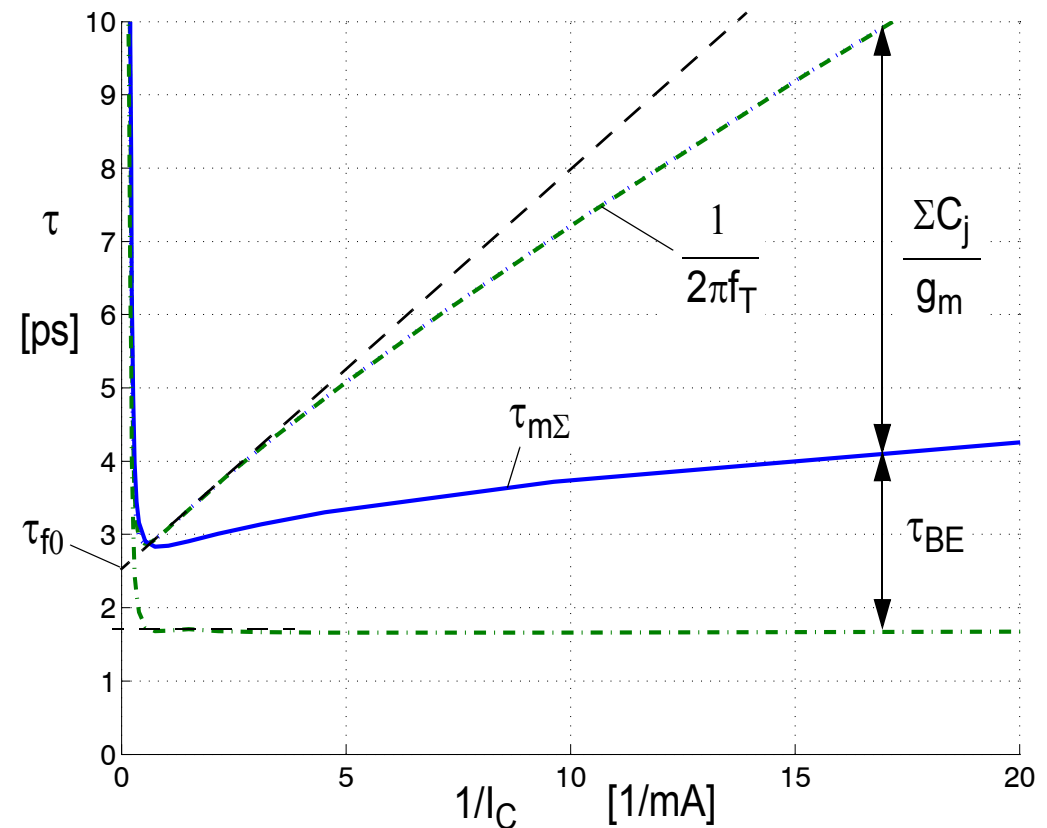
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Additional slides: Results and Discussion

Reciprocal f_T and related storage times vs $1/I_C$ for BJT

- standard transit time determination method
 $\Rightarrow \tau_f = \tau_{f0}(V_{BC}) + \Delta\tau_f(I_T, V_{BC})$
- slope is usually assumed to be caused by depletion caps
- improved method includes curvature (from V_{BE} dependence of C_{jE})
- in reality: curvature and portion of offset caused by neutral charge in BE SCR



\Rightarrow **extracted C_{jE} always includes portion of neutral BE charge**